TYPICAL APPLICATIONS

- Carrier Grade Ethernet/SONET/SDH/PDH Network Interface Cards
- GPON ONT/ONU
- T1/E1 line cards
- DS3/E3 line cards

PRODUCT PACKAGING & AVAILABILITY

Part Number	Package Type	Pin Count	Lead-Free Option	Shipping Option(s)	Lead Time(wks)	Status
ZL30321GGG	LFBGA	100		Trays. Bake & Drypack	10-12 weeks	Production
ZL30321GGG	LFBGA	100		Trays. Bake & Drypack	10-12 weeks	Production
ZL30321GGG2	LFBGA	100	Pb-free-Tin/Silver/Copper	Trays. Bake & Drypack	14-16 weeks	Production
ZL30321GGG2	LFBGA	100	Pb-free-Tin/Silver/Copper	Trays. Bake & Drypack	14-16 weeks	Production
ZL30321GKG	TEBGA-2	256		Trays. Bake & Drypack	10-12 weeks	Production
ZL30321GKG	TEBGA-2	256		Trays. Bake & Drypack	10-12 weeks	Production
ZL30321GKG2	TEBGA-2	256	Pb-free-Tin/Silver/Copper	Trays. Bake & Drypack	10-12 weeks	Production
ZL30321GKG2	TEBGA-2	256	Pb-free-Tin/Silver/Copper	Trays. Bake & Drypack	10-12 weeks	Production

PACKAGING INFORMATION

- Soldering ProfilesMoisture Sensitivity
- Shelf Life
- Reliability Data

TECHNICAL SUPPORT

Registered users click here to access the service.

Not registered? Register online today and get access to all our technical support services.

Forgot your password?

Visit the page to find distributor, representative and Zarlink sales office contact information.

 $@\ 2013\ Microsemi\ Corporation.\ All\ rights\ reserved.\ |\ Site\ Terms\ \&\ Conditions\ |\ Privacy\ Policy\ |\ Contact$